ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® international and	nposition De 5. IPC, Bannockt Pan-American co	c laration ourn, Illinois. A opyright conver	ll rights reserved u ntions.	nder both	This docume level parts, t	ent is a declaration he declaration er	on of the substancompasses all 1	aces within the man ower level materia	nufacturer liste ls for which th	ed item. Note: ne manufactur	if the item is an as er has engineering	sembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Distribution http://www.ipc.org/IPC-175x Form Distribution								Materials and	ials and Mfg Information			
upplier Information													
ompany name*	Company un	Company unique ID			Unique ID Authority				Response Date*				
nsemi									2024-06-05				
Contact Name Ti			Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards P			Product Enviro Compliance			NA			Pro	Product-Env-Stewards@onsemi.com			
Authorized Representative* Ti			Title - Representative			Phone - Representative*			Ema	Email - Representative*			
Product-Env-Stewards P			Product Enviro Compliance			NA			Pro	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		nber Mfr Item Name			Effective Date	Version	Manufacturing	Site	Weight*	UOM	Unit Type	
	QRE111	QRE1113 4L REFL		REFLECT SNSR GULLW		2024-06-05		EVERLGFG		47.893	mg	Each	
Ianufacturing Proccess Inform	nation												
Terminal Plating / Grid Array	Terminal Plating / Grid Array Material Terminal		ase Alloy J-STD-020 MSL		Rating	Peak Proce	Peak Process Body Temperate		at Peak Temp	erature Num	nber of Reflow Cyc	cles	
Matte Tin (Sn) - annealed		CU Alloy NA		NA		0 C		30	se	conds 3			
omments													
or more information regarding mater	ial composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl ate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.266	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.047	mg
			Supplier	Silicon (Si)	7440-21-3		0.219	mg
Die Attach	0.003	mg	Supplier	Silver (Ag)	7440-22-4		0.002	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.001	mg
Lead Frame	47.571	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.0904	mg
			Supplier	Silver (Ag)	7440-22-4		1.0703	mg
			Supplier	Fiber Glass (SiO2)	65997-17-3		0.4805	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0048	mg
			Supplier	Polyphthalamide	27135-32-6		0.6375	mg
			Supplier	Copper (Cu)	7440-50-8		45.2876	mg
Resin Encapsulaltion	0.052	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		0.052	mg
Wire Bond - Au	0.001	mg	Supplier	Gold (Au)	7440-57-5		0.001	mg